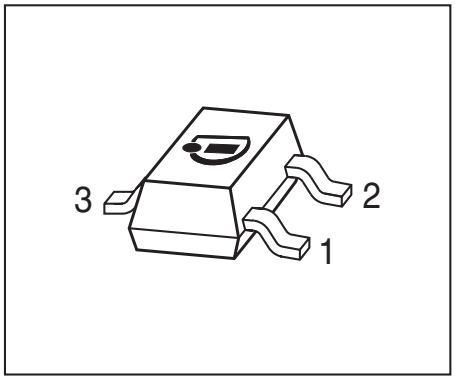
PNP Silicon Switching Transistor



- Low collector-emitter saturation voltage
- Complementary type:
  SMBT2222A / MMBT2222A (NPN)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101

Type	Marking	Pin Configuration			Package
SMBT2907A/MMBT2907A	s2F	1 = B	2 = E	3 = C	SOT23

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	60	V
Collector-base voltage	V_{CBO}	60	
Emitter-base voltage	V_{EBO}	5	
Collector current	I_C	600	mA
Base current	I_B	100	
Peak base current	I_{BM}	200	
Total power dissipation $T_S \leq 77$ °C	P_{tot}	330	mW
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point[1)]	R_{thJS}	≤ 220	K/W

[1]For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

Electrical Characteristics at T_A = 25°C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage I_C = 10 mA, I_B = 0	$V_{(BR)CEO}$	60	-	-	V
Collector-base breakdown voltage I_C = 10 µA, I_E = 0	$V_{(BR)CBO}$	60	-	-	
Emitter-base breakdown voltage I_E = 10 µA, I_C = 0	$V_{(BR)EBO}$	5	-	-	
Collector-base cutoff current V_{CB} = 50 V, I_E = 0 V_{CB} = 50 V, I_E = 0 , T_A = 150 °C	I_{CBO}	 - -	 - -	 0.01 10	µA
Emitter-base cutoff current V_{EB} = 5 V, I_C = 0	I_{EBO}	-	-	10	nA
DC current gain[1)] I_C = 100 µA, V_{CE} = 10 V I_C = 1 mA, V_{CE} = 10 V I_C = 10 mA, V_{CE} = 10 V I_C = 150 mA, V_{CE} = 10 V I_C = 500 mA, V_{CE} = 10 V	h_{FE}	 75 100 100 100 50	 - - - - -	 - - - 300 -	-
Collector-emitter saturation voltage[1)] I_C = 150 mA, I_B = 15 mA I_C = 500 mA, I_B = 50 mA	V_{CEsat}	 - -	 - -	 0.4 1.6	V
Base emitter saturation voltage-[1)] I_C = 150 mA, I_B = 15 mA I_C = 500 mA, I_B = 50 mA	V_{BEsat}	 - -	 - -	 1.3 2.6	

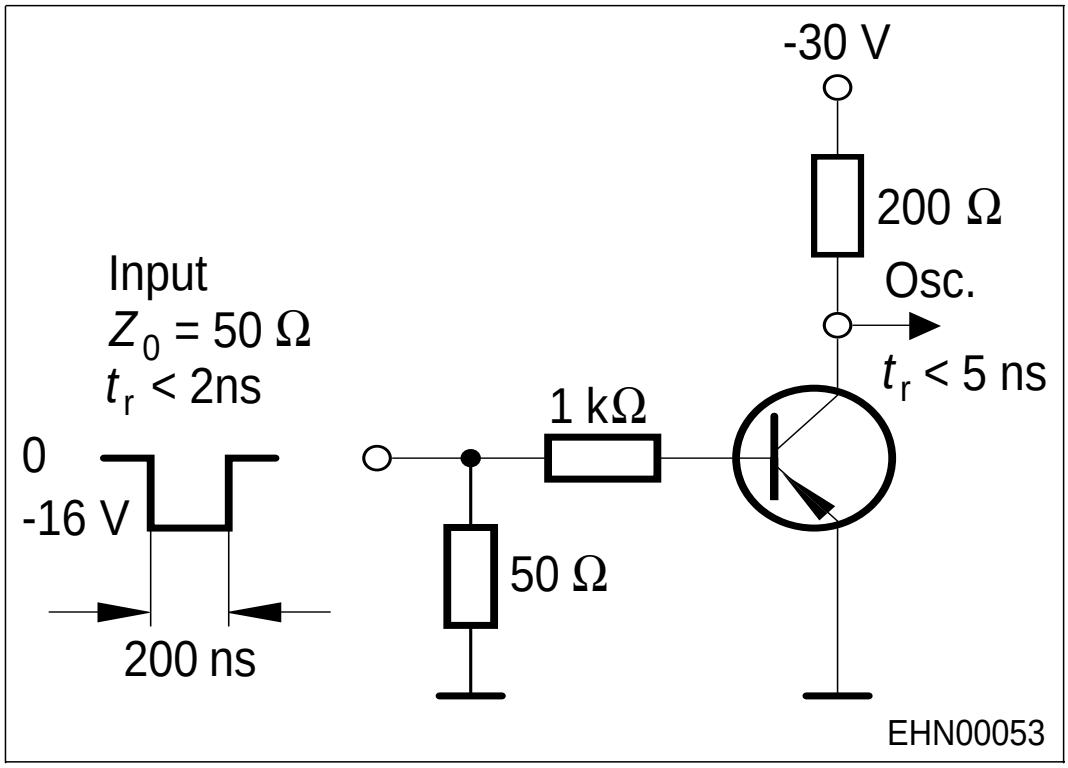
[1]Puls test: t ≤ 300µs, D = 2%

Electrical Characteristics at T_A = 25°C, unless otherwise specified

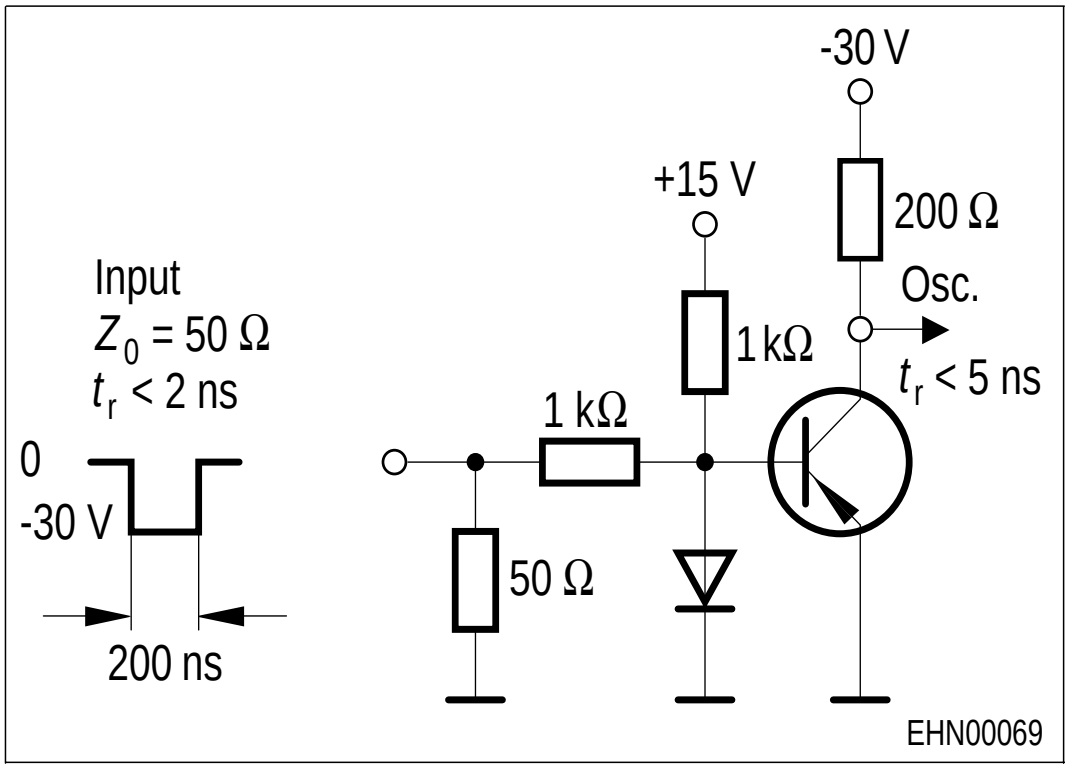
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Transition frequency I_C = 20 mA, V_{CE} = 20 V, f = 100 MHz	f_T	200	-	-	MHz
Collector-base capacitance V_{CB} = 10 V, f = 1 MHz	C_{cb}	-	-	8	pF
Emitter-base capacitance V_{EB} = 0.5 V, f = 1 MHz	C_{eb}	-	-	30	
Delay time V_{CC} = 30 V, I_C = 150 mA, I_{B1} = 15 mA, $V_{BE(off)}$ = 0.5 V	t_d	-	-	10	ns
Rise time V_{CC} = 30 V, I_C = 150 mA, I_{B1} = 15 mA, $V_{BE(off)}$ = 0.5 V	t_r	-	-	40	
Storage time V_{CC} = 30 V, I_C = 150 mA, I_{B1} = I_{B2} = 15mA	t_{stg}	-	-	80	
Fall time V_{CC} = 30 V, I_C = 150 mA, I_{B1} = I_{B2} = 15mA	t_f	-	-	30	

Test circuit

Delay and rise time



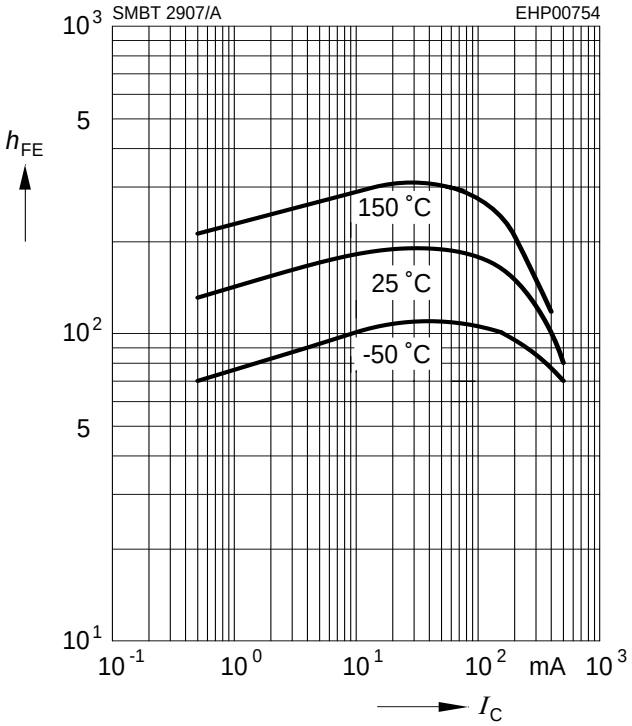
Storage and fall time



Oscillograph: R > 100, C < 12pF, t_r < 5ns

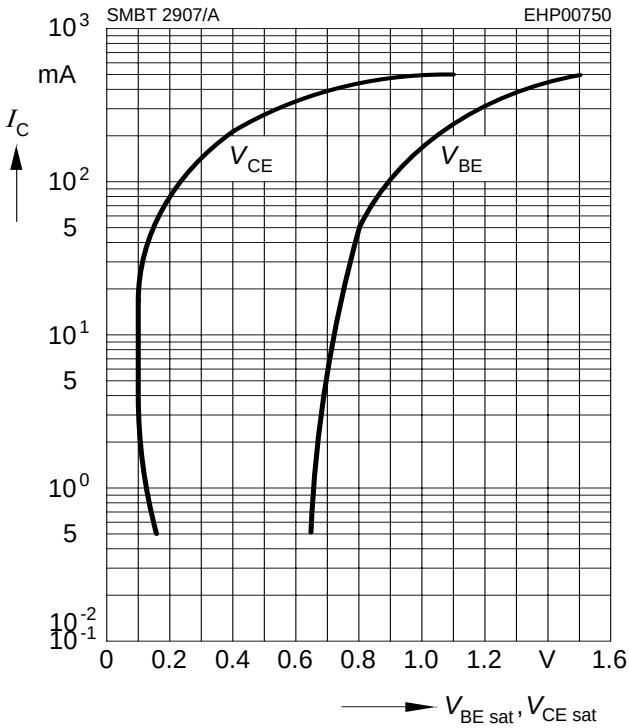
DC current gain $h_{FE} = f(I_C)$

V_{CE} = 5 V



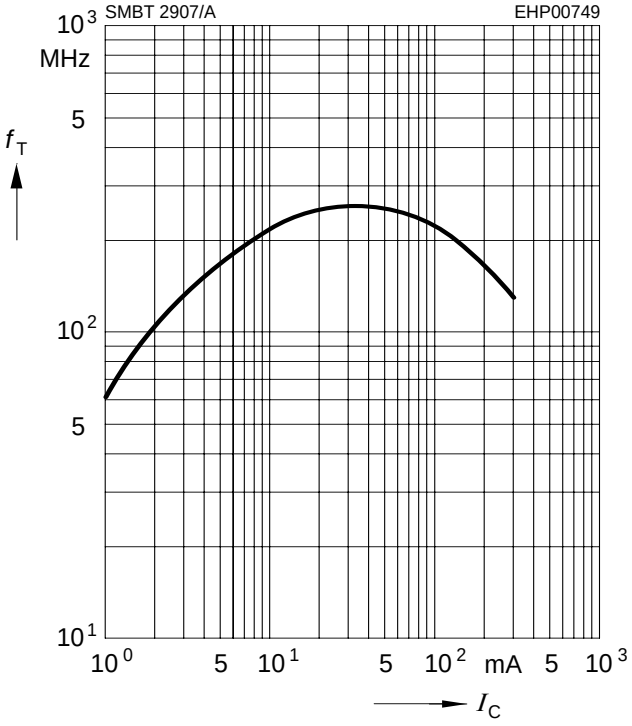
Saturation voltage $I_C = f(V_{BEsat}; V_{CEsat})$

h_{FE} = 10



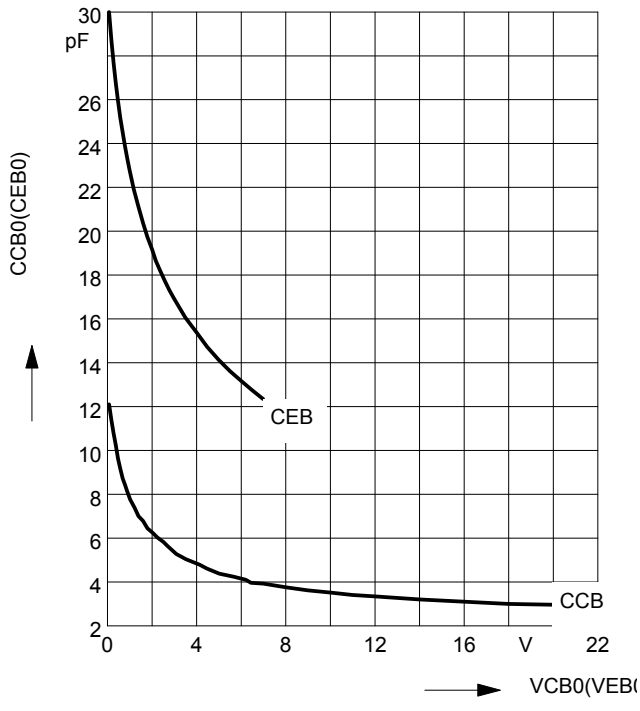
Transition frequency $f_T = f(I_C)$

V_{CE} = 5 V



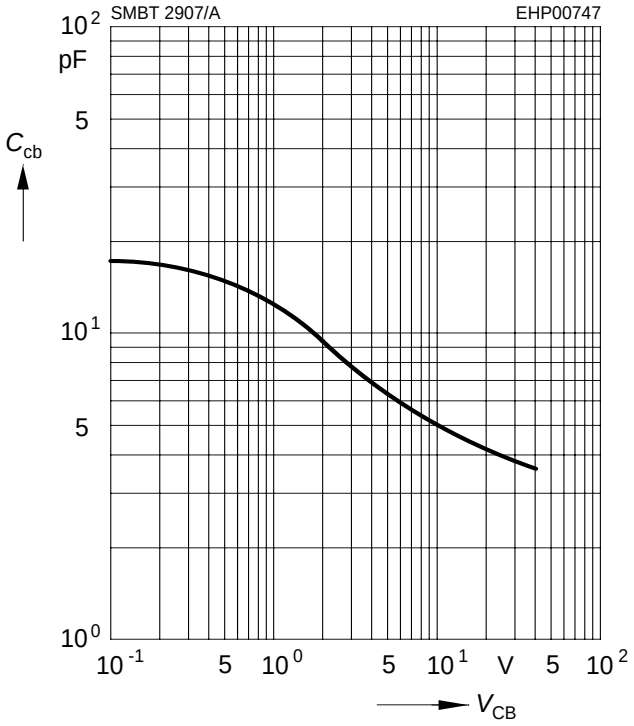
Collector-base capacitance $C_{cb} = f(V_{CB})$

Emitter-base capacitance $C_{eb} = f(V_{EB})$

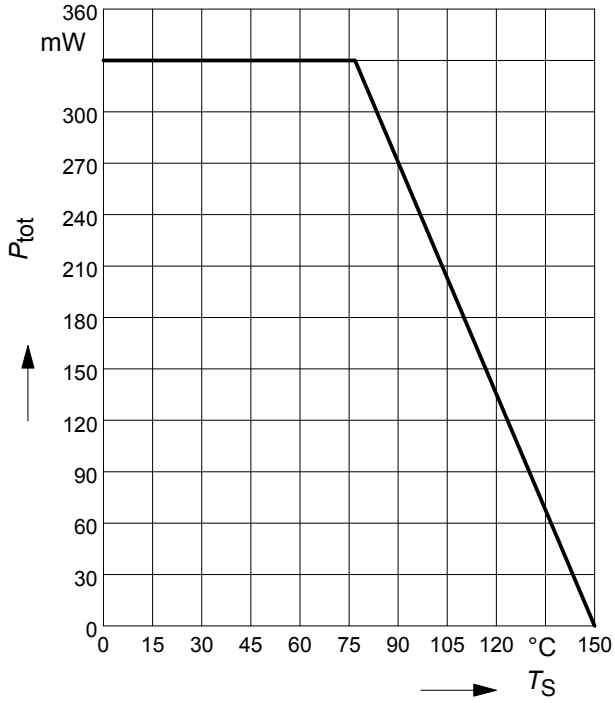


Collector-base capacitance C_{CB}= f (V_{CB})

f = 1MHz

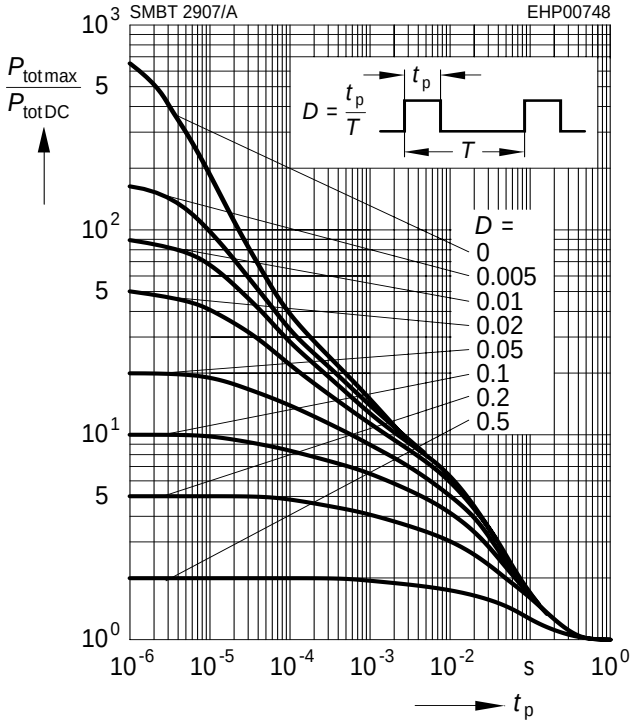


Total power dissipation P_{tot} = f(T_S)



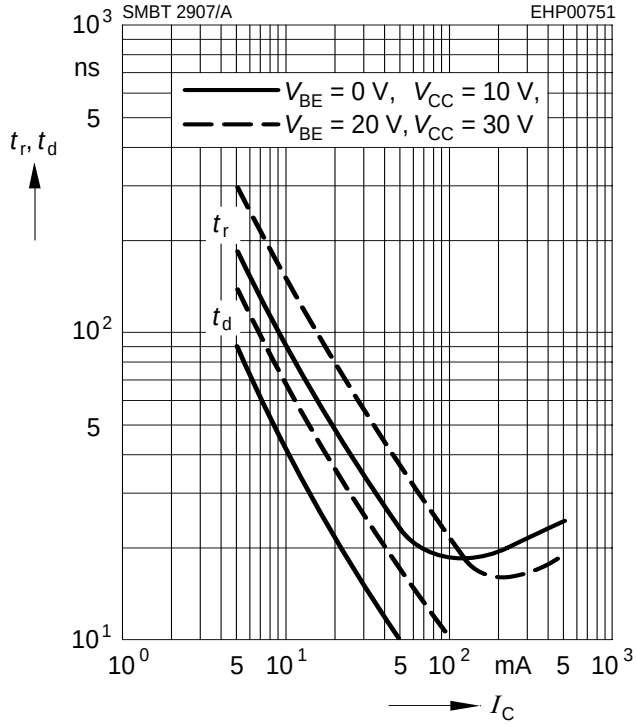
Permissible Pulse Load

P_{totmax}/P_{totDC} = f(t_p)

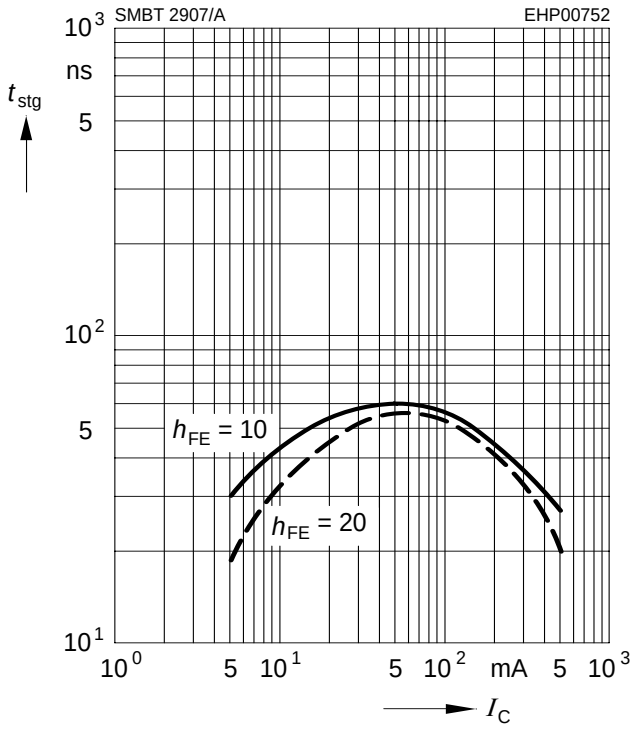


Delay time t_d = f(I_C)

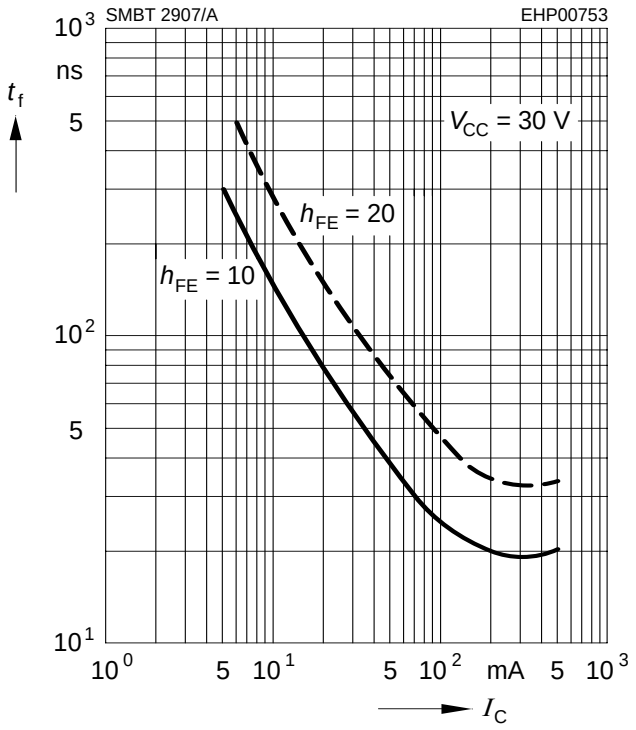
Rise time t_r = f(I_C)



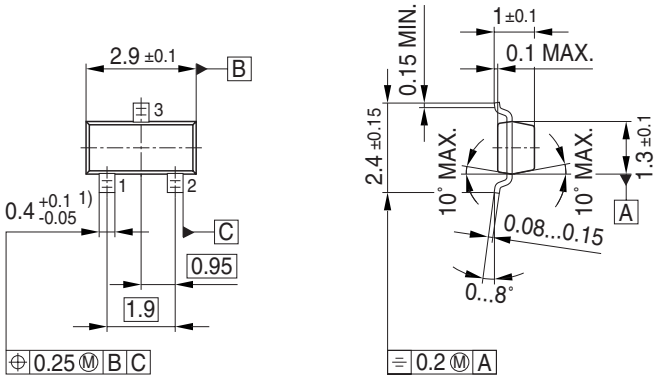
Storage time t_{stg} = $f(I_C)$



Fall time t_f = $f(I_C)$

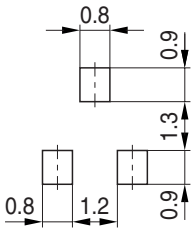


Package Outline

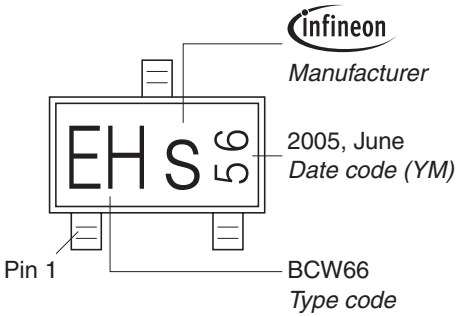


1) Lead width can be 0.6 max. in dambar area

Foot Print

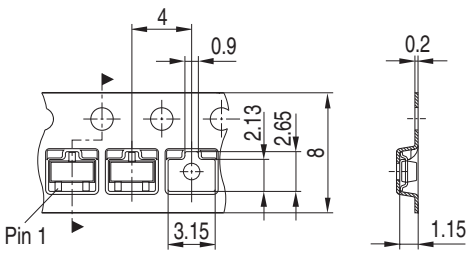


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



Edition 2009-11-16

Published by
Infineon Technologies AG
81726 Munich, Germany

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<www.infineon.com>).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.
Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:
SMBT2907AE6327HTSA1